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N-Channel PowerTrench[®] MOSFET 60 V, 22 A, 8.2 m Ω

Features

- \blacksquare Max $r_{DS(on)}$ = 8.2 m Ω at V_{GS} = 10 V, I_D = 13.5 A
- Max $r_{DS(on)}$ = 11.7 m Ω at V_{GS} = 4.5 V, I_D = 11.5 A
- Advanced package and silicon combination for low r_{DS(on)} and high efficiency
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

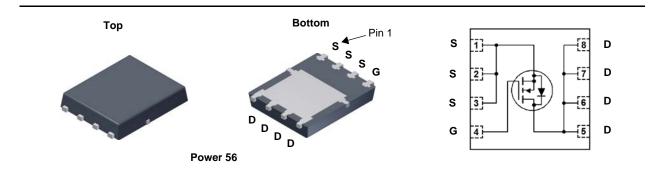


General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency and to minimize switch node ringing of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $r_{DS(on)}$, fast switching speed and body diode reverse recovery performance.

Applications

- Primary Switch in isolated DC-DC
- Synchronous Rectifier
- Load Switch



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Param	eter		Ratings	Units	
V _{DS}	Drain to Source Voltage			60	V	
V _{GS}	Gate to Source Voltage			±20	V	
	Drain Current -Continuous	T _C = 25 °C		22		
I _D	-Continuous	T _A = 25 °C	(Note 1a)	13.5	Α	
	-Pulsed			60		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	91	mJ	
D	Power Dissipation	T _C = 25 °C		69	w	
P _D	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5	vv	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	1.8	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient (Note 1a)	50	C/vv

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86520L	FDMS86520L	Power 56	13 "	12 mm	3000 units

October 2014

Max	Units	
	V	
	mV/°C	
1	μA	
±100	nA	
3	V]
	mV/°C	
8.2		
11.7	mΩ	
11.8		
	S	
		-
4615	pF pF	
835	pF	
45	pF	

Ω

ns

ns

ns

ns

nC

nC

nC

nC

 ш
SWC
MS86520L N
20L
N-C
N-Channel F
nel F
Pow
erTr
werTrench
h® N
MOSF
FET
•

_ · J						
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 48 V, V_{GS} = 0 V$			1	
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 V, V_{DS} = 0 V$			±100	
On Chara	acteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$	1	1.8	3	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-7		1
		V _{GS} = 10 V, I _D = 13.5 A		6.7	8.2	
r.	Static Drain to Source On Resistance	$V_{GS} = 4.5 V, I_D = 11.5 A$		9.1	11.7	
r _{DS(on)}		V _{GS} = 10 V, I _D = 13.5 A, T _J = 125 °C		9.6	11.8	
9 _{FS}	Forward Transconductance	V _{DS} = 5 V, I _D = 13.5 A		51		
-	Characteristics					
C _{iss}	Input Capacitance	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$		3470	4615	1
C _{oss}	Output Capacitance	$v_{DS} = 30 v, v_{GS} = 0 v,$ 		625	835	
C _{rss}	Reverse Transfer Capacitance			25	45	L
Rg	Gate Resistance			0.6		
Switchin	g Characteristics					
t _{d(on)}	Turn-On Delay Time			15	27	
t _r	Rise Time	V _{DD} = 30 V, I _D = 13.5 A,		5.6	11	
t _{d(off)}	Turn-Off Delay Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		32	52	
t _f	Fall Time			3.4	10	
Qg	Total Gate Charge	$V_{GS} = 0 V \text{ to } 10 V$		45	63	
Qg	Total Gate Charge	$V_{GS} = 0$ V to 4.5 V $V_{DD} = 30$ V,		21	30	
Q _{gs}	Gate to Source Charge	I _D = 13.5 A		9.5		

Test Conditions

 $I_D = 250 \ \mu A$, referenced to 25 °C

 $I_D = 250 \ \mu\text{A}, \ V_{GS} = 0 \ V$

Min

60

Тур

29

Drain-Source Diode Characteristics

Gate to Drain "Miller" Charge

Electrical Characteristics T_J = 25 °C unless otherwise noted

Parameter

Drain to Source Breakdown Voltage

Breakdown Voltage Temperature

Symbol

 BV_{DSS}

 $\Delta T_{\rm J}$

 ΔBV_{DSS}

Off Characteristics

Coefficient

V _{SD}		$V_{GS} = 0 V, I_S = 2.1 A$ (Note 2)	0.72	1.2	V
		V _{GS} = 0 V, I _S = 13.5 A (Note 2)	0.83	1.3	v
t _{rr}	Reverse Recovery Time	I _F = 13.5 A, di/dt = 100 A/μs	37	60	ns
Q _{rr}	Reverse Recovery Charge	$F = 13.5 \text{ A}, \text{ u/ut} = 100 \text{ A/} \mu \text{s}$	21	34	nC
t _{rr}	Reverse Recovery Time	I _F = 13.5 A, di/dt = 300 A/μs	30	48	ns
Q _{rr}	Reverse Recovery Charge	$F = 13.5 \text{ A, u/u} = 300 \text{ A/}\mu\text{s}$	37	59	nC

Notes:

Q_{gd}

1. $R_{\theta,JR}$ is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. $R_{\theta,JC}$ is guaranteed by design while $R_{\theta,CA}$ is determined by the user's board design.



a. 50 °C/W when mounted on a 1 in² pad of 2 oz copper.

minimum pad of 2 oz copper.

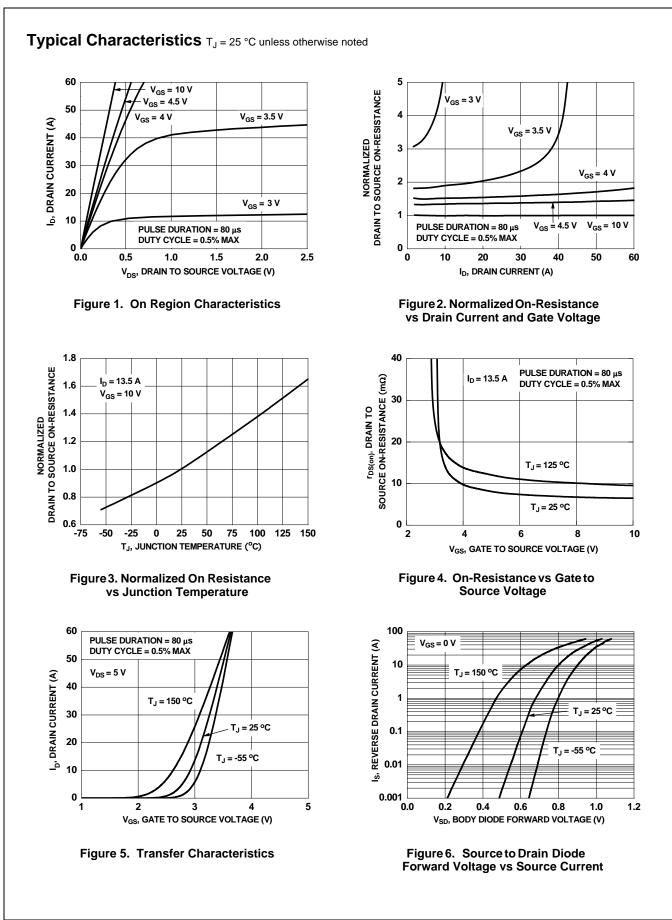
4.7

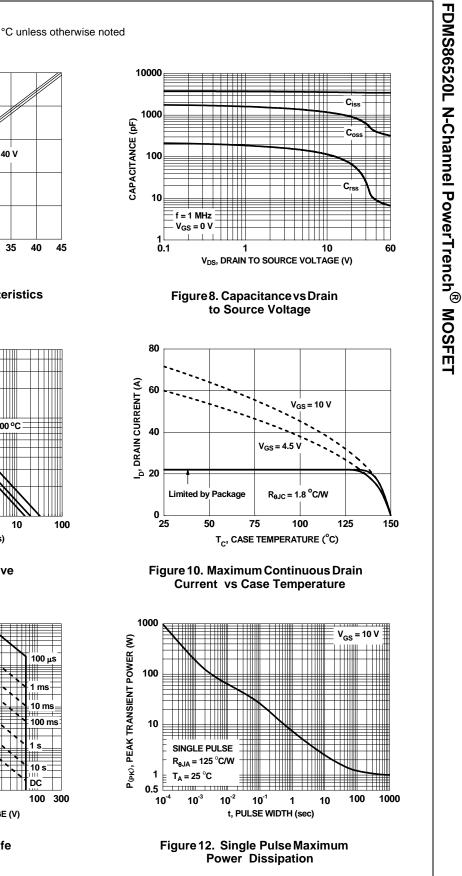
b. 125 °C/W when mounted on a



2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%.

3. Starting T_J = 25 °C, L = 1 mH, I_{AS} = 13.5 A, V_{DD} = 54 V, V_{GS} = 10 V. 100% test at L = 0.1 mH, I_{AS} = 29 A.





Typical Characteristics $T_J = 25 \text{ °C}$ unless otherwise noted

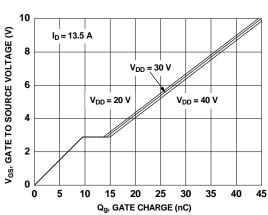
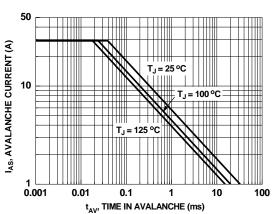
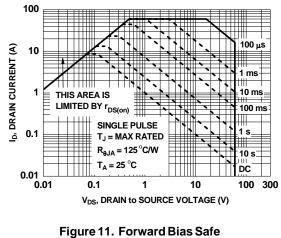


Figure 7. Gate Charge Characteristics

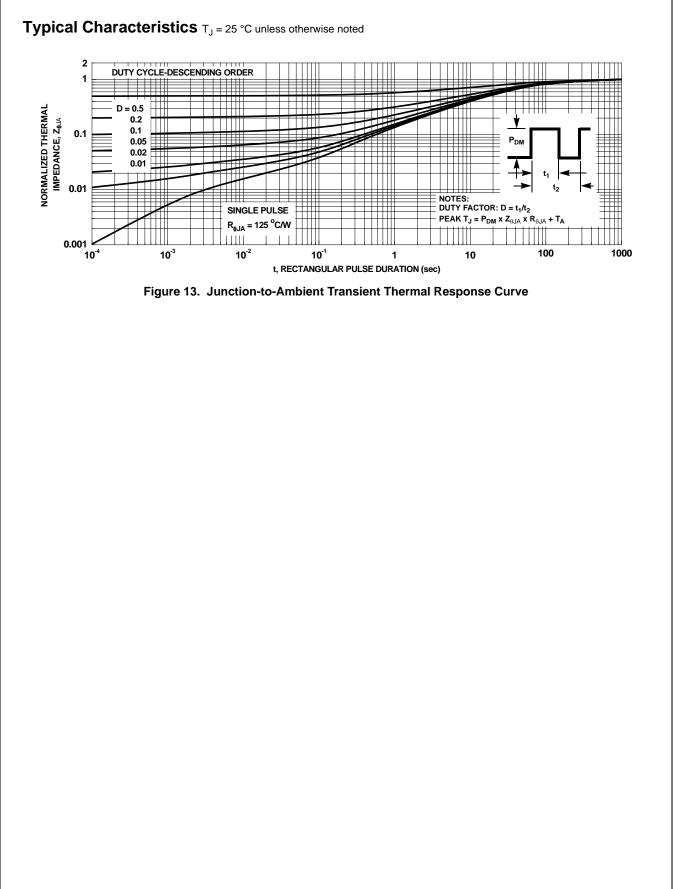






Operating Area

4





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